



SPN3004 N-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPN3004 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application , notebook computer power management and other battery powered circuits where high-side switching .

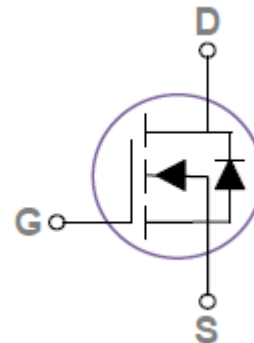
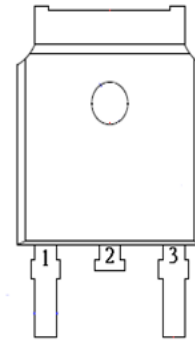
FEATURES

- ◆ 30V/96A, $R_{DS(ON)}=4.2m\Omega@V_{GS}=10V$
- ◆ 30V/96A, $R_{DS(ON)}=6.0m\Omega@V_{GS}=4.5V$
- ◆ Super high density cell design for extremely low $R_{DS(ON)}$
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ TO-252-2L package design

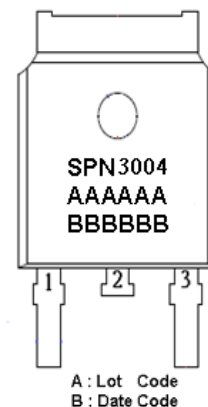
APPLICATIONS

- MB/VGA/Vcore
- POL Applications
- SMPS 2nd SR
- High Frequency Synchronous Buck Converter
- DC/DC Power System
- Load Switch

PIN CONFIGURATION(TO-252-2L)



PART MARKING





SPN3004

N-Channel Enhancement Mode MOSFET

PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	D	Drain
3	S	Source

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN3004T252RGB	TO-252-2L	SPN3004

※ SPN3004T252RGB : Tape Reel ; Pb – Free; Halogen - Free

ABSOLUTE MAXIMUM RATINGS

($T_A=25^{\circ}\text{C}$ Unless otherwise noted)

Parameter	Symbol	Typical	Unit	
Drain-Source Voltage	V_{DS}	30	V	
Gate –Source Voltage	V_{GS}	± 20	V	
Continuous Drain Current($T_J=150^{\circ}\text{C}$)	I_D	$T_A=25^{\circ}\text{C}$	96	A
		$T_A=100^{\circ}\text{C}$	68	
Pulsed Drain Current	I_{DM}	192	A	
Avalanche Current	I_{AS}	53.8	A	
Single Pulse Avalanche Energy	E_{AS}	317	mJ	
Power Dissipation	P_D	93	W	
Operating Junction Temperature	T_J	-55/150	$^{\circ}\text{C}$	
Storage Temperature Range	T_{STG}	-55/150	$^{\circ}\text{C}$	
Thermal Resistance-Junction to Ambient	$R_{\theta JA}$	62	$^{\circ}\text{C}/\text{W}$	



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ELECTRICAL CHARACTERISTICS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250uA	30			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _{DS} =250uA	1.2	1.6	2.5	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =24V, V _{GS} =0V, T _J =25°C			1	uA
		V _{DS} =24V, V _{GS} =0V, T _J =125°C			10	
Drain-Source On-Resistance	R _{DSS(on)}	V _{GS} =10V, I _D =30A		3.8	4.2	mΩ
		V _{GS} =4.5V, I _D =15A		5.2	6.0	
Forward Transconductance	g _{fs}	V _{DS} =10V, I _D =6A		12		S
Diode Forward Voltage	V _{SD}	I _F =1A, V _{GS} =0V			1	V
Dynamic						
Total Gate Charge	Q _g	V _{DS} =15V, V _{GS} =4.5V, I _D =12A		24	34	nC
Gate-Source Charge	Q _{gs}			4.2	6	
Gate-Drain Charge	Q _{gd}			13	18	
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =25V, F=1MHz		2200	3190	pF
Output Capacitance	C _{oss}			280	405	
Reverse Transfer Capacitance	C _{rss}			177	255	
Turn-On Time	t _{d(on)}	(V _{DD} =15V, I _D =15A, V _{GEN} =10V, R _G =3.3Ω)		12.6	24	ns
	t _r			19.5	37	
Turn-Off Time	t _{d(off)}			42.8	81	
	t _f			13.2	25	



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TYPICAL CHARACTERISTICS

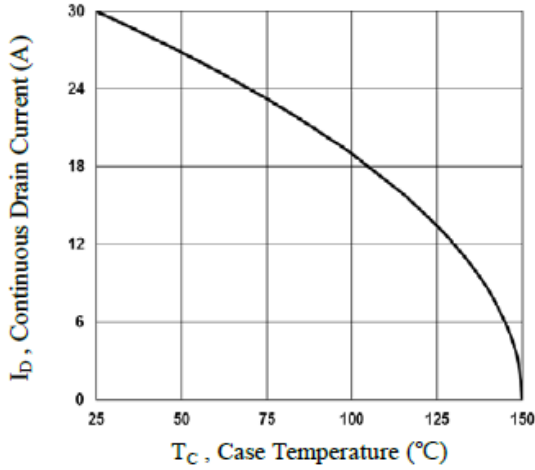


Fig.1 Continuous Drain Current vs. T_C

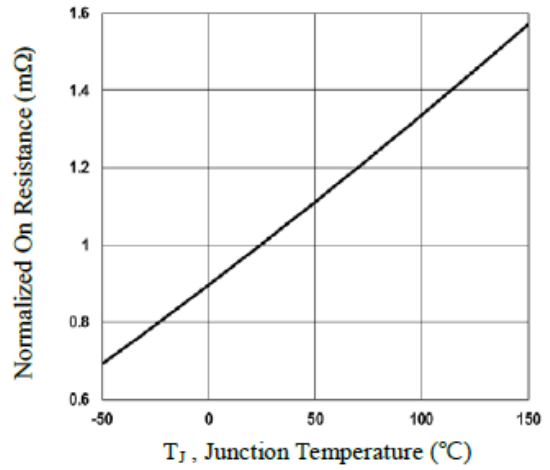


Fig.2 Normalized $R_{DS(on)}$ vs. T_J

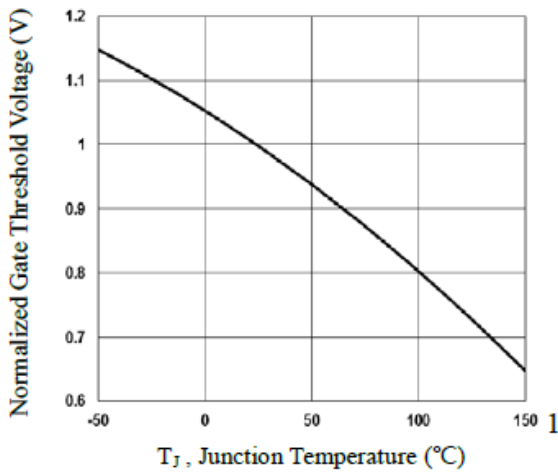


Fig.3 Normalized V_{th} vs. T_J

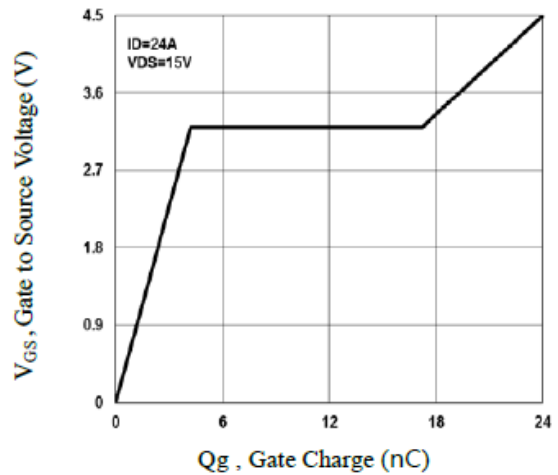


Fig.4 Gate Charge Waveform

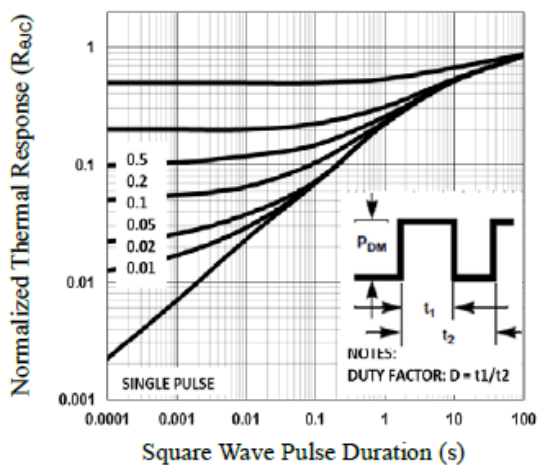


Fig.5 Normalized Transient Impedance

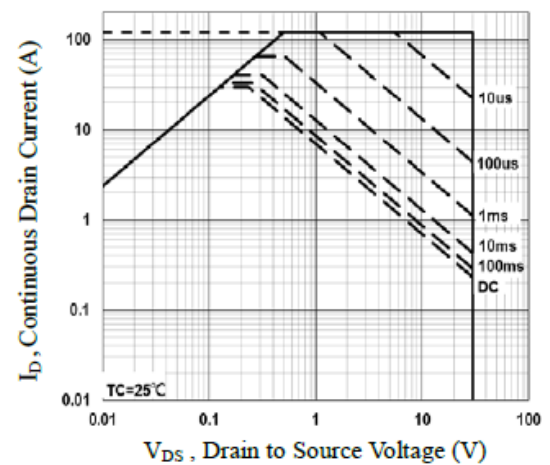


Fig.6 Maximum Safe Operation Area



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TYPICAL CHARACTERISTICS

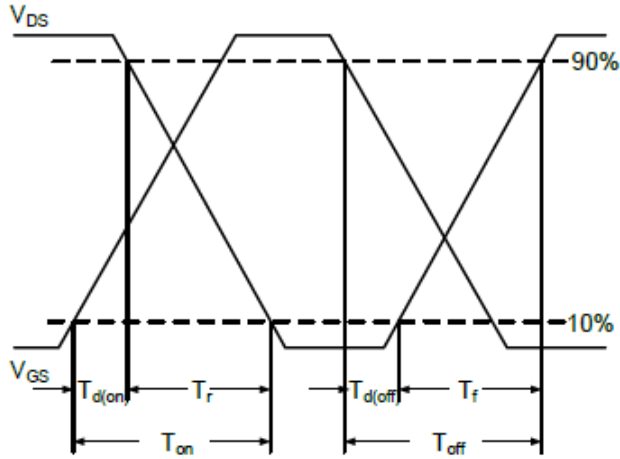


Fig.7 Switching Time Waveform

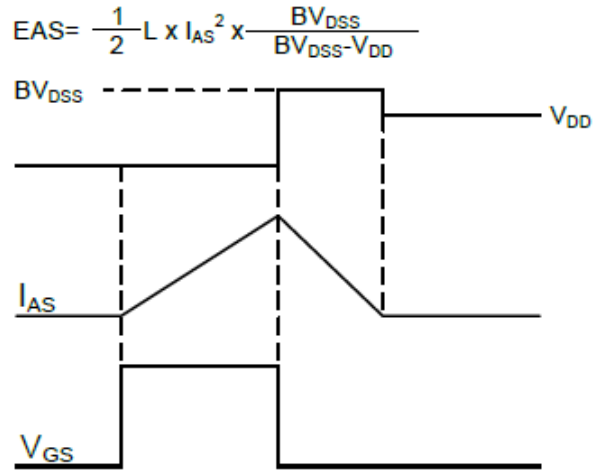
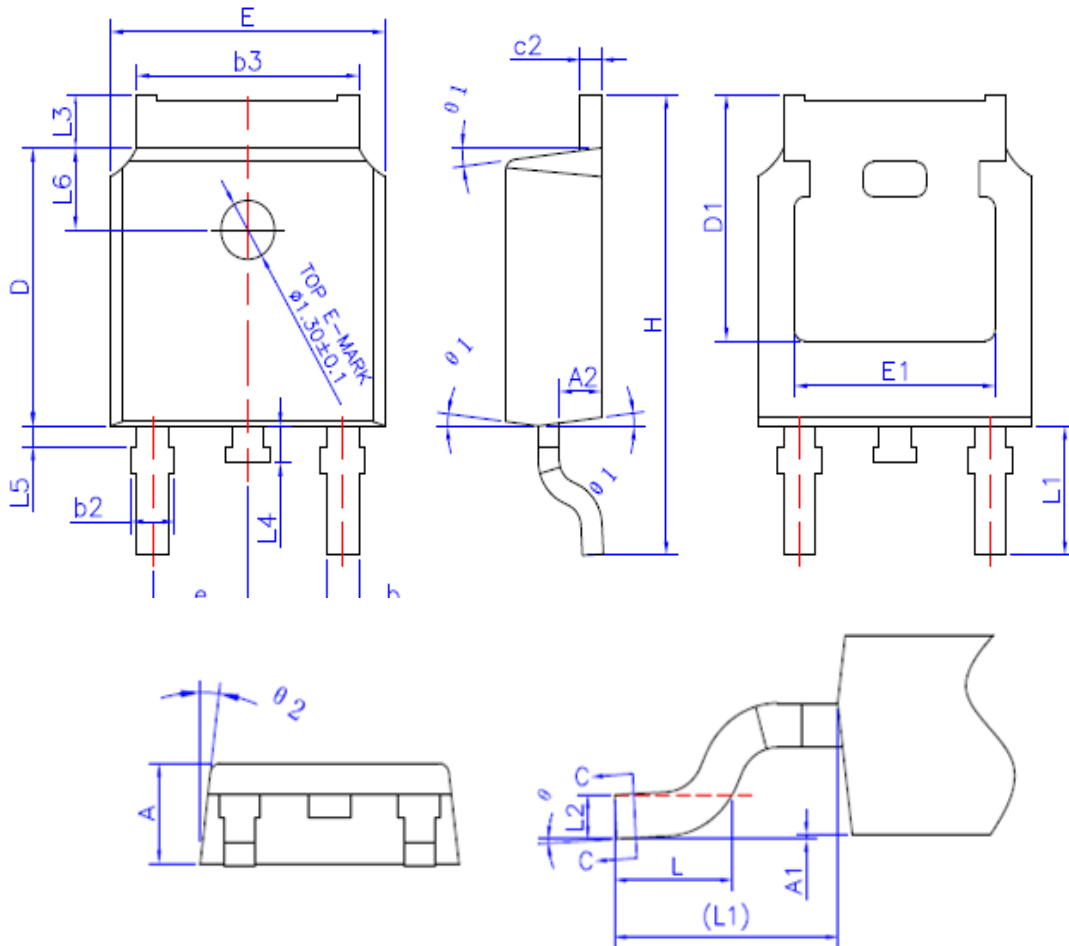


Fig.8 EAS Waveform



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TO-252-2L PACKAGE OUTLINE

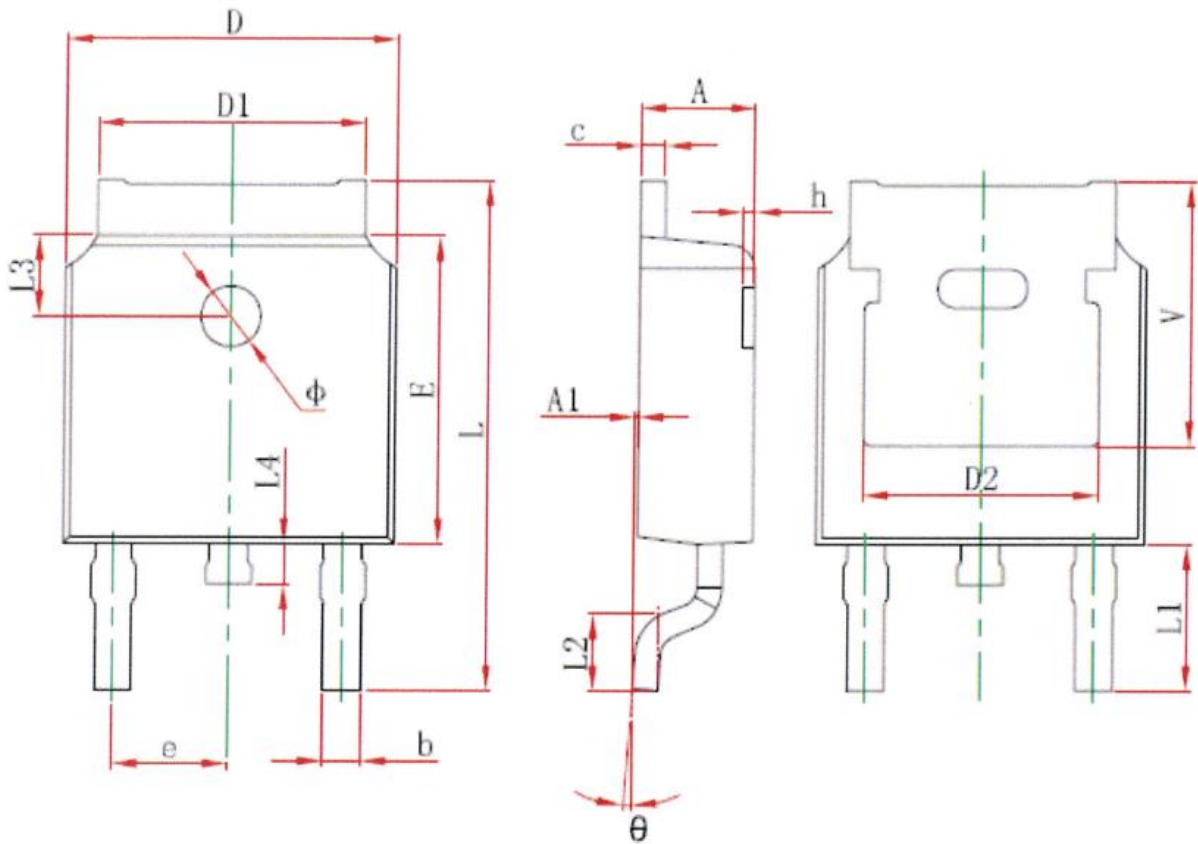


SYMBOL	MIN	NOM	MAX
A	2.20	2.30	2.40
A1	0.00	--	0.15
A2	0.90	1.01	1.10
b	0.72	-	0.85
b2	0.72	--	0.90
b3	5.13	5.33	5.46
c	0.47	--	0.60
c2	0.47	--	0.60
D	6.00	6.10	6.20
D1	5.25	--	--
E	6.40	6.60	6.80
E1	4.70	--	--
e	2.3REF		
H	9.80	10.10	10.40
L	1.40	1.60	1.80
L1	2.90REF		
L2	0.508BSC		
L3	0.90	--	1.25
L4	0.60	0.80	1.00
L5	0.15	--	0.75
L6	1.80REF		
θ	0°	3°	8°
θ 1	5°	7°	9°
θ 2	5°	7°	9°



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TO-252-2L PACKAGE OUTLINE



Symbol	Dimensions In Millimeters	
	Min.	Max.
A	2.200	2.400
A1	0.000	0.127
b	0.660	0.860
c	0.460	0.580
D	6.500	6.700
D1	5.100	5.460
D2	4.830 REF.	
E	6.000	6.200
e	2.186	2.386
L	9.800	10.400
L1	2.900 REF.	
L2	1.400	1.700
L3	1.600 REF.	
L4	0.600	1.000
Φ	1.100	1.300
θ	0°	8°
h	0.000	0.300
V	5.350 REF.	



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